



DATASHET_ SKIUU-NH

9TH GEN INTEL® XEON® MIL-STD FANLESS RUGGED COMPUTER



- MIL-STD810G compliant
- 9th Gen Intel® Xeon® processor with up to 6 cores and 45W/25W TDP
- 2 x DDR4 2666 MHz SODIMM up to 64GB
- 2 x Full size (PCIe x1 & USB 2.0)
 M.2 2230 E key (Wifi / BT)
- 9V to 36V DC-Input
- Extended Temperature -40°C to 60°C

Specifications

SYSTEM

High Power Processor	Xeon E-2276ME (6 Cores/12 Threads, 12M Cache, up to 4.50 GHz), 45W
	Xeon E-2276ML (6 Cores/12 Threads, 12M Cache, up to 4.20 GHz), 25W
Chipset	CM246
memory type	2 x DDR4 2666 MHz SODIMM up to 64GB (horizontal type)
Graphic	Intel® UHD Graphics 630
Ethernet	I219LM +3 x I210iT
Audio codec	ALC887
Power Type	9V~36V DC IN
STORAGE	
SSD	2 x SATA3.0
EXPANSION SLOT	
M.2	1 x M.2 (M-key, type:2280, SATA/PCIe 3.0x4 NVMe)
Mini-PCI	2 x Full size (PCIe x1,USB 2.0 and micro SIM Card)
FRONT I/O	
Button	1x Power Button
DC-IN	1 x 4P Rugged Terminal connector
REAR I/O	
Display Port	1 x Display Port
	1 X HDMI
USB	4 x USB3.0
Audio	2 x 3.5mm Audio Jacls(1 x MIC, 1 x Line-out)
Serial Port	1 x DB9 connector (RS232/422/485)
Ethernet	4 x RJ45 GbE LAN
APPLICATIONS, OP	ERATING SYSTEM
Applications	Commercial and Military Platforms Requiring Compliance to MIL-STD-810G
	Embedded Computing, Process Control, Intelligent Automation and
	manufacturing applications where Harsh Temperature, Shock, Vibration,
	Altitude, Dust and EMI Conditions. Used in all aspects of the military
Operating System	Windows 10 32/64Bit

PHYSICAL

Dimension	250 x 149 x 76 mm
Weight	3.6 Kg (7.94 lbs)
Chassis	Aluminum Alloy, Corrosion Resistant
Finish	Anodic aluminum oxide (Color Iron gray)
Cooling	Natural Passive Convection/Conduction. No Moving Parts.
Connectors	IP65 Waterproof connectors
Ingress Protection	Dust proof (Similar to IP50)
MECHANICAL AND	ENVIRONMENT
Reliability	No Moving Parts; Passive Cooling.
	Designed & Manufactured using ISO 9001/2000 Certified Quality
	Program.
Operating Temp	-40°C to 70°C
Storage Temp.	-40°C to 85°C
TEST STANDARD	
	Method 507.5, Procedure II (Temperature & Humidity)
	Method 516.6 Shock-Procedure V Non-Operating (Mechanical Shock)
	Method 516.6 Shock-Procedure I Operating (Mechanical Shock)
	Method 514.6 Vibration Category 24/Non-Operating (Category 20 & 24,
	Vibration) Method 514.6 Vibration Category 20/Operating (Category 20 & 24
	Vibration) Method 501.5, Procedure I (Storage/High Temperature)
	Method 501.5, Procedure II (Operation/High Temperature)
	Method 502.5, Procedure I (Storage/Low Temperature)
	Method 502.5, Procedure II (Operation/Low Temperature)
	Method 503.5, Procedure I (Temperature shock)
EMC	CE and FCC compliance
Green Product	RoHS, WEEE compliance

Ordering Information

SR100-X4

Xeon E-2276ME, DDR4-4GB, 128GB SSD, 9V~36V MIL-461/1275

SR100-X4E

Xeon E-2276ML, DDR4-4GB, 128GB SSD, 9V~36V MIL-461/1275

Dimension

